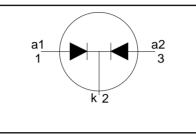
### **BYQ30EX** series

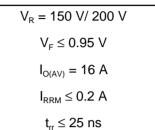
#### **FEATURES**

- Low forward volt drop
- · Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
  Isolated mounting tab

#### **SYMBOL**



### QUICK REFERENCE DATA



#### **GENERAL DESCRIPTION**

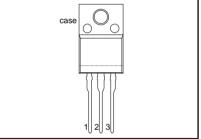
Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYQ30EX series is supplied in the conventional leaded SOT186A package.

#### PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | anode 1     |
| 2   | cathode     |
| 3   | anode 2     |
| tab | isolated    |
|     |             |

# **SOT186A**



#### **LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL   | PARAMETER  | CONDITIONS  | MIN.     | MA                               | AX.                              | UNIT        |
|--|--|---|----------|----------------------------------|----------------------------------|-------------|
| V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | Peak repetitive reverse voltage<br>Crest working reverse voltage<br>Continuous reverse voltage | BYQ30EX   | -<br>-   | <b>-150</b><br>150<br>150<br>150 | <b>-200</b><br>200<br>200<br>200 | V<br>V<br>V |
| I <sub>O(AV)</sub>                                     | Average rectified output current (both diodes conducting) <sup>1</sup>                         | square wave $\delta = 0.5$ ; T <sub>bs</sub> $\leq 59$ °C                         | -        | 1                                | 6                                | A           |
| I <sub>FRM</sub>                                       | Repetitive peak forward current  | t = 25 μs; 'δ = 0.5;<br>T <sub>hs</sub> ≤ 59 °C                                   | -        | 1                                | 6                                | A           |
| I <sub>FSM</sub>                                       | Non-repetitive peak forward current per diode  | t = 10 ms<br>t = 8.3 ms<br>sinusoidal; with reapplied<br>$V_{RWM(max)}$ S = 0.001 | -        |                                  | 00<br>10                         | A<br>A      |
| I <sub>RRM</sub>                                       | Repetitive peak reverse current per diode  | $t_{p} = 2 \ \mu s; \ \delta = 0.001$   | -        | 0                                | .2                               | A           |
| I <sub>RSM</sub>                                       | Non-repetitive peak reverse current per diode  | t <sub>p</sub> = 100 μs   | -        | 0                                | .2                               | A           |
| T <sub>stg</sub><br>T <sub>j</sub>                     | Storage temperature<br>Operating junction temperature  |   | -40<br>- |                                  | 50<br>50                         | Ĵ<br>Ĵ      |

#### **ESD LIMITING VALUE**

| SYMBOL | PARAMETER                                    | CONDITIONS  | MIN. | MAX. | UNIT |  |
|--------|--|---|------|------|------|--|
| Vc     | Electrostatic discharge<br>capacitor voltage | Human body model;<br>C = 250 pF; R = 1.5 k $\Omega$ | -    | 8    | kV   |  |

<sup>1</sup> Neglecting switching and reverse current losses.

**BYQ30EX** series

### **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs} = 25$  °C unless otherwise specified

| SYMBOL            | PARAMETER  | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|-------------------|--|--|------|------|------|------|
| V <sub>isol</sub> | R.M.S. isolation voltage from all three terminals to external heatsink | f = 50-60 Hz; sinusoidal waveform;<br>R.H. $\leq$ 65% ; clean and dustfree | -    |      | 2500 | V    |
| C <sub>isol</sub> | Capacitance from T2 to external heatsink                               | f = 1 MHz  | -    | 10   | -    | pF   |

#### THERMAL RESISTANCES

| SYMBOL                                      | PARAMETER | CONDITIONS   | MIN. | TYP.         | MAX.            | UNIT              |
|---|-----------|--|------|--------------|-----------------|-------------------|
| R <sub>th j-hs</sub><br>R <sub>th j-a</sub> | heatsink  | with heatsink compound<br>without heatsink compound<br>in free air |      | -<br>-<br>55 | 5.0<br>7.0<br>- | K/W<br>K/W<br>K/W |

#### **ELECTRICAL CHARACTERISTICS**

characteristics are per diode at  $T_i = 25$  °C unless otherwise stated

| SYMBOL          | PARAMETER                     | CONDITIONS  | MIN. | TYP. | MAX. | UNIT |
|-----------------|-------------------------------|---|------|------|------|------|
| V <sub>F</sub>  | Forward voltage               | I <sub>F</sub> = 8 A; T <sub>i</sub> = 150°C  | -    | 0.83 | 0.95 | V    |
|                 |                               | I <sub>F</sub> = 16 Å; T <sub>i</sub> = 150°C   | -    | 1.0  | 1.15 | V    |
|                 |                               | I <sub>F</sub> = 16 A;  | -    | 0.98 | 1.25 |      |
| I <sub>R</sub>  | Reverse current               | $V_{R} = V_{RWM}$ ; T <sub>j</sub> = 100 °C   | -    | 0.3  | 0.6  | mA   |
|                 |                               | $V_{R} = V_{RWM}$   | -    | 2    | 30   | μA   |
| Q <sub>s</sub>  | Reverse recovery charge       | $ I_{\rm F} = 2 \text{ A}; V_{\rm R} \ge 30 \text{ V}; -dI_{\rm F}/dt = 20 \text{ A}/\mu\text{s}$ | -    | 4    | 11   | nC   |
| t <sub>rr</sub> | Reverse recovery time         | $I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$  | -    | 20   | 25   | ns   |
|                 |                               | -dI <sub>F</sub> /dt = 100 A/μs   |      |      |      |      |
| I Irrm          | Peak reverse recovery current | $I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$  | -    | 1.0  | 2    | Α    |
|                 |                               | l-dl <sub>c</sub> /dt = 50 A/us: T₁ = 100 °C  |      |      |      |      |
| V <sub>fr</sub> | Forward recovery voltage      | $I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = 10 \text{ A}/\mu\text{s}$                            | -    | 1    | -    | V    |

 $I_{F}$ 

I R

F

 $^{\sf V}{}_{\sf F}$ 

12

10

8

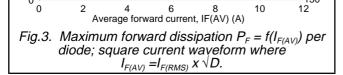
6

4

2

0

#### Ths(max) / C 90 dl F Forward dissipation, PF (W) 12 Vo = 0.75 V Rs 0.025 Ohms dt 10 100 a = 1.57 1.9 110 8 2.2 2.8 time 6 120 130 4 Q 100% 10% 140 2 l rrm 150 0 2 3 4 5 6 Average forward current, IF(AV) (A) 0 7 8 Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where $a = form factor = I_{F(RMS)} / I_{F(AV)}$ . Fig.1. Definition of t<sub>rr</sub>, Q<sub>s</sub> and I<sub>rrm</sub> trr / ns 1000 IF=10A 100 time IF=1A 10 V <sub>fr</sub> V F 1 -1 10 dIF/dt (A/us) 100 time Fig.2. Definition of $V_{tr}$ Fig.5. Maximum $t_{rr}$ at $T_i = 25$ °C. Ths(max) / C 80 trr / ns Forward dissipation, PF (W) 1000 Vo = 0.75 V Rs = 0.025 Ohms D = 1.0 90 0.5 IF=10A 110 100 0.2 JF=1A 0.1 120 $\mathbf{t}_{\mathsf{p}}$ D = 130 10 140 t



100

Rev 1.200

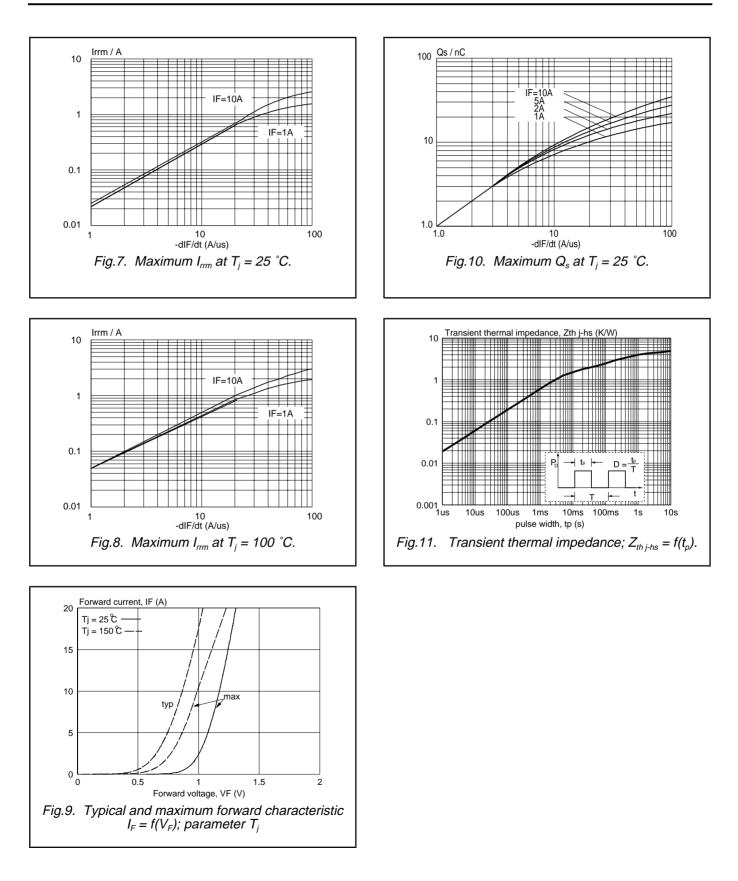
10 dIF/dt (A/us)

Fig.6. Maximum  $t_{rr}$  at  $T_i = 100$  °C.

1 -1

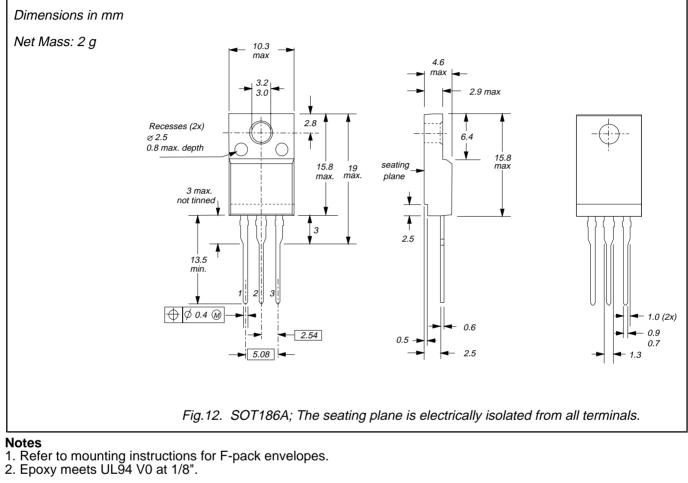
150

### **BYQ30EX** series



### **BYQ30EX** series

#### **MECHANICAL DATA**



#### **BYQ30EX** series

#### DEFINITIONS

| Data sheet status  |   |  |  |  |
|--|---|--|--|--|
| Objective specification This data sheet contains target or goal specifications for product development.  |   |  |  |  |
| Preliminary specification  | Preliminary specification This data sheet contains preliminary data; supplementary data may be published later. |  |  |  |
| Product specification  | This data sheet contains final product specifications.  |  |  |  |
| Limiting values  |   |  |  |  |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |   |  |  |  |
| Application information  |   |  |  |  |
| Where application information is given, it is advisory and does not form part of the specification.  |   |  |  |  |
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#### LIFE SUPPORT APPLICATIONS

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